



Customer Information Notification

2018110411

Issue Date: 19-Dec-2018
Effective Date: 20-Dec-2018

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.



QUALITY

Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

NXP-ATTJ Final Test to KESM
Tianjin Final Test Expansion
(NEVIS2_WCT and
ANGUILLA_SILVER_WCT)

Description

NXP Semiconductors announces the Final Test site expansion for the products associated with this notification, from the current NXP-ATTJ Tianjin, China Final Test site to the KESM Tianjin Final Test site.

Final Test site transfer was successfully qualified adhering to NXP specifications.

Corresponding ZVEI Delta Qualification Matrix ID: SEM-TF-01

Please see the attached files for additional details.

Reason

Capacity Expansion: Qualification of the external Test site KESM Tianjin is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

NXP will reserve the right to ship from any location based on market demand situation.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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Affected Part Numbers

MWCT1001AVLH

MWCT1003AVLHR

MWCT1003AVLH

MWCT1013VLH

MWCT1012CFM

MWCT1011AVLH

MWCT1013AVLH